

# Common Anode Silicon Dual Switching Diode

## M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

This Common Anode Silicon Epitaxial Planar Dual Diode is designed for use in ultra high speed switching applications. This device is housed in the SC-70 package which is designed for low power surface mount applications.

### Features

- Fast  $t_{rr} < 10$  ns
- Low  $C_D < 15$  pF
- AEC-Q101 Qualified and PPAP Capable
- S & NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant\*

### MAXIMUM RATINGS ( $T_A = 25$ °C)

Rating	Symbol	Value	Unit
Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	$V_R$	40 80	Vdc
Peak Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	$V_{RM}$	40 80	Vdc
Forward Current Single Dual	$I_F$	100 150	mAdc
Peak Forward Current Single Dual	$I_{FM}$	225 340	mAdc
Peak Forward Surge Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	$I_{FSM}$ (Note 1)	500 750	mAdc

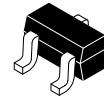
### THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Power Dissipation	$P_D$	150	mW
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{stg}$	-55 ~ +150	°C

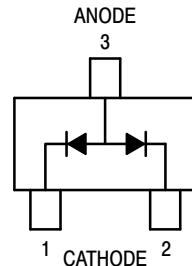
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1.  $t = 1$  sec

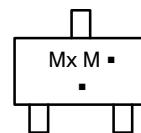
\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



SC-70 (SOT-323)  
CASE 419  
STYLE 4



### MARKING DIAGRAM



Mx = Device Code

x = N for 141

O for 142

M = Date Code\*

▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
M1MA141WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel
NSVM1MA141WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel
M1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel
SM1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

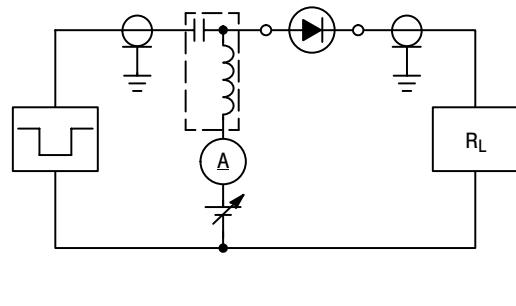
## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

Characteristic	Condition	Symbol	Min	Max	Unit
Reverse Voltage Leakage Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V <sub>R</sub> = 35 V V <sub>R</sub> = 75 V	I <sub>R</sub>		0.1 0.1	µAdc
Forward Voltage	I <sub>F</sub> = 100 mA	V <sub>F</sub>		1.2	Vdc
Reverse Breakdown Voltage M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G	I <sub>R</sub> = 100 µA	V <sub>R</sub>	40 80		Vdc
Diode Capacitance	V <sub>R</sub> = 0, f = 1.0 MHz	C <sub>D</sub>		15	pF
Reverse Recovery Time (Figure 1)	I <sub>F</sub> = 10 mA, V <sub>R</sub> = 6.0 V, R <sub>L</sub> = 100 Ω, I <sub>rr</sub> = 0.1 I <sub>R</sub>	t <sub>rr</sub> (Note 2)		10	ns

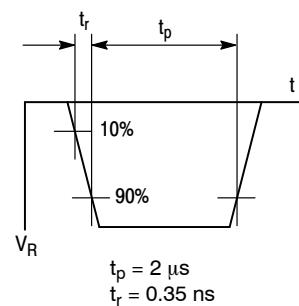
2. t<sub>rr</sub> Test Circuit

# M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

## RECOVERY TIME EQUIVALENT TEST CIRCUIT



## INPUT PULSE



## OUTPUT PULSE

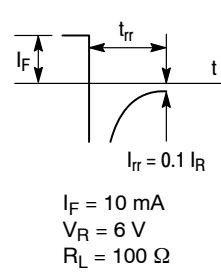


Figure 1. Recovery Time Equivalent Test Circuit

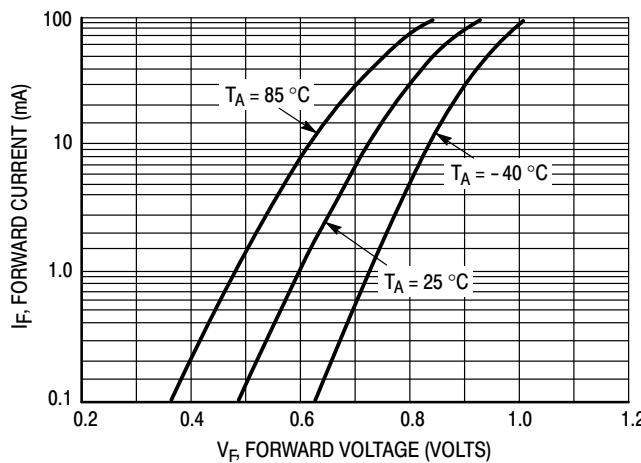


Figure 2. Forward Voltage

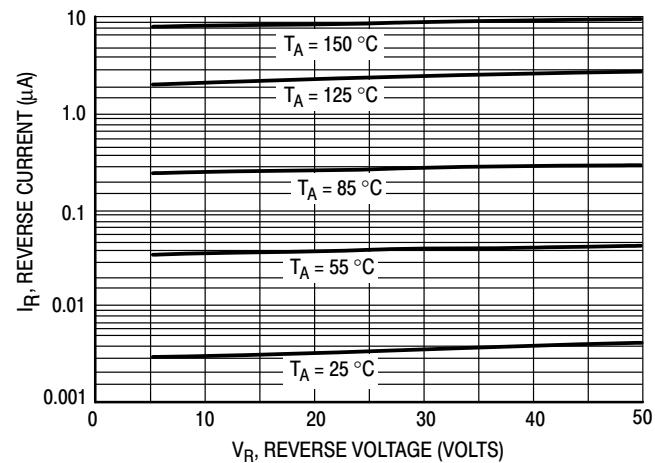


Figure 3. Reverse Current

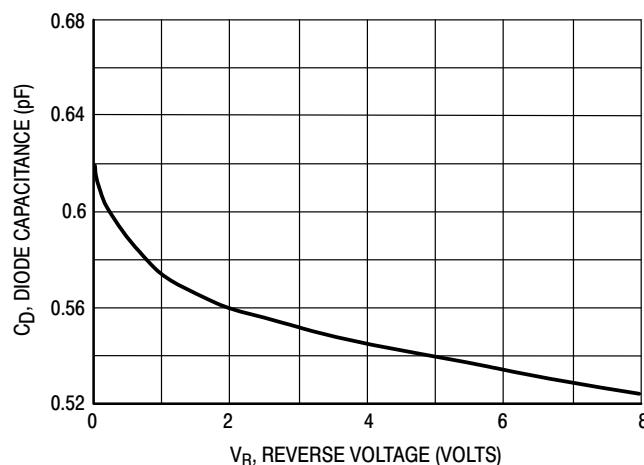


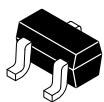
Figure 4. Diode Capacitance

# **M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G**

## **REVISION HISTORY**

<b>Revision</b>	<b>Description of Changes</b>	<b>Date</b>
12	Added a new OPN and edited one bullet	11/19/2025

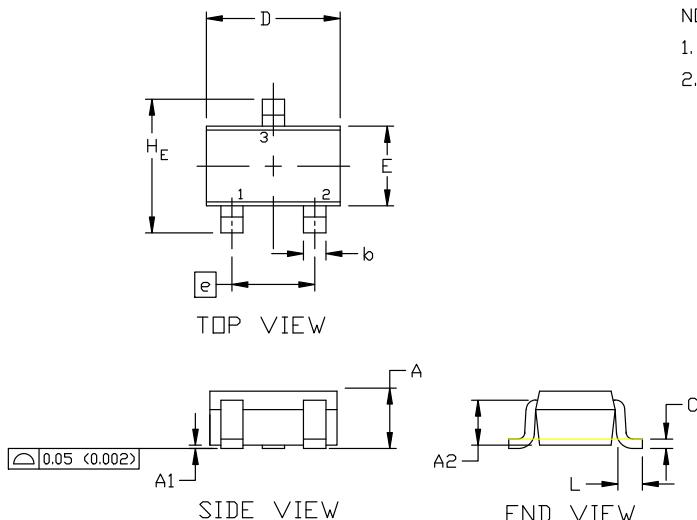
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.



SCALE 4:1

SC-70 (SOT-323)  
CASE 419  
ISSUE R

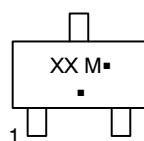
DATE 11 OCT 2022



## NOTES:

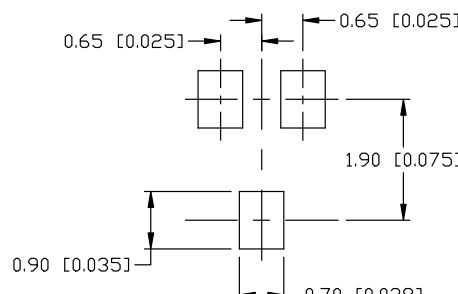
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH

DIM	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 BSC		
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.00	2.20	0.071	0.080	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
H_E	2.00	2.10	2.40	0.079	0.083	0.095

GENERIC  
MARKING DIAGRAM

XX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## SOLDERING FOOTPRINT

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. Emitter 3. Collector	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE
STYLE 6: PIN 1. Emitter 2. BASE 3. COLLECTOR	STYLE 7: PIN 1. BASE 2. Emitter 3. COLLECTOR	STYLE 8: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 9: PIN 1. ANODE 2. CATHODE 3. CATHODE-ANODE	STYLE 10: PIN 1. CATHODE 2. ANODE 3. ANODE-CATHODE
				STYLE 11: PIN 1. CATHODE 2. CATHODE 3. CATHODE

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DESCRIPTION:	SC-70 (SOT-323)	PAGE 1 OF 1

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